

Dual P-Channel -20 V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ.)		
	0.65 at V _{GS} = -4.5 V	-0.30			
-20	0.84 at V _{GS} = -2.5 V	-0.25	0.75		
	1.20 at V _{GS} = -1.8 V	-0.18			

FEATURES

- TrenchFET[®] Power MOSFET
- 100 % R_g Tested
- Gate-Source ESD Protected: 1000 V

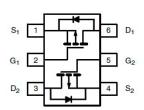


RoHS

APPLICATIONS

- Load/Power Switching for Portable Devices
- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories
- Battery Operated Systems
- Power Supply Converter Circuits

SC-75-6



Top View

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)						
Parameter	Symbol	Limit	Unit			
Drain-Source Voltage		V _{DS}	-20	V		
Gate-Source Voltage		V _{GS}	± 12	v		
Continuous Dunin Commant (T., 150 °C)	T _A = 25 °C	I_	-0.30 ^{a, b}			
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 70 °C	ID	-0.15 ^{a, b}	A		
Pulsed Drain Current		I _{DM}	-2			
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	-0.18 ^{a, b}	Α		
Manianum Danum Dissipational	T _A = 25 °C	P _D	0.22 ^{a, b}	w		
Maximum Power Dissipation ^a	T _A = 70 °C	υ .	0.14 ^{a, b}			
Operating Junction and Storage Temperature Ra	ange	T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Тур.	Max.	Unit	
Maximum Junction-to-Ambient ^b	t ≤ 5 s	R _{thJA}	470 5	565	°C/W	
waximum junction-to-Ambient	Steady State	' 'thJA	560	675	O/ VV	

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. t = 5 s.



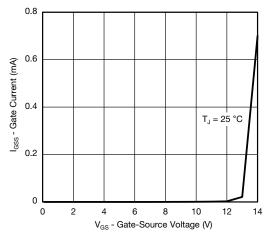
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-20			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	In = -250 IIA		-17		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			- 1.8			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	-0.5		-1.5	V	
Gate-Source Leakage	1	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 30		
	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 4.5 \text{ V}$			± 1	Ī ,.,	
Zero Gate Voltage Drain Current	I	V _{DS} = -20 V, V _{GS} = 0 V			-1	μΑ	
Zero date voltage Diam Guirent	I _{DSS}	V_{DS} = -20 V, V_{GS} = 0 V, T_{J} = 85 °C			-3	1	
On-State Drain Current ^a	I _{D(on)}	$_{DS}$ = \geq -5 V, V_{GS} = -4.5 V	-2			Α	
		$V_{GS} = -4.5 \text{ V}, I_D = -0.3 \text{A}$		0.650			
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = -2.5 \text{ V}, I_D = -0.25 \text{A}$		0.840		Ω	
		$V_{GS} = -1.8 \text{ V}, I_D = -0.18 \text{A}$		1.20			
Forward Transconductance	9 _{fs}	$V_{DS} = -10 \text{ V}, I_{D} = -0.3 \text{A}$		7.5		S	
Dynamic ^b				L	l	1	
Input Capacitance	C _{iss}			120			
Output Capacitance	C _{oss}	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		14		pF	
Reverse Transfer Capacitance	C _{rss}			8			
Tabal Oaks Observe	Q _g	$V_{DS} = -10 \text{ V}, V_{GS} = -8 \text{ V}, I_D = -0.3 \text{ A}$		1.3	2	nC	
Total Gate Charge				0.75	1.2		
Gate-Source Charge		$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = 0.3 \text{ A}$		0.15			
Gate-Drain Charge	Q _{gd}			0.13			
Gate Resistance	R _g	f = 1 MHz	2.4	12.2	24.4	Ω	
Turn-On Delay Time	t _{d(on)}			11	20		
Rise Time t _r		V_{DD} = -10 V, R_L = 20 Ω		16	24	ns	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 0.5 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$		26	39	113	
Fall Time	t _f			11	20	1	
Drain-Source Body Diode Characterist	ics						
Pulse Diode Forward Current ^a	I _{SM}				-2	Α	
Body Diode Voltage	V_{SD}	I _S =- 0.3 A		-0.8	-1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			10	15	ns	
Body Diode Reverse Recovery Charge	Q_{rr}	L = 0.5.A. dl/dt = 100.A/va		2	4	nC	
Reverse Recovery Fall Time	t _a	I _F = 0.5 A, dl/dt = 100 A/μs		5		ne	
Reverse Recovery Rise Time	t _b	7		5		ns	

- a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.

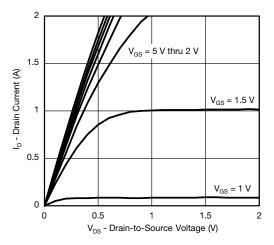
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



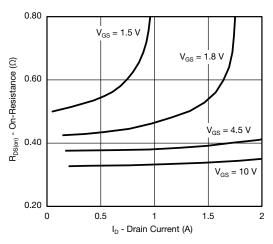
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



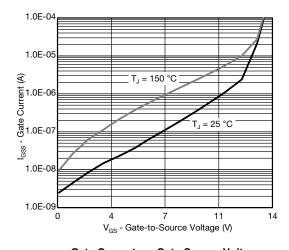
Gate Current vs. Gate-Source Voltage



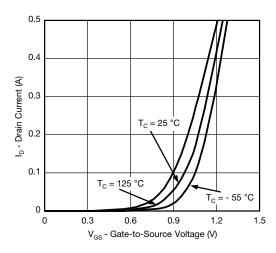
Output Characteristics



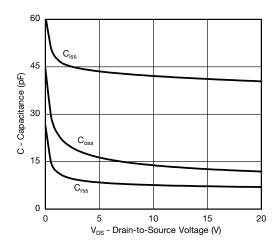
On-Resistance vs. Drain Current



Gate Current vs. Gate-Source Voltage



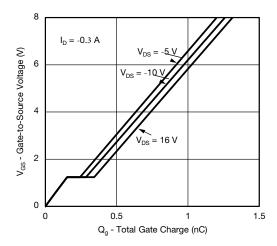
Transfer Characteristics



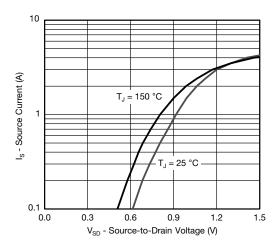
Capacitance



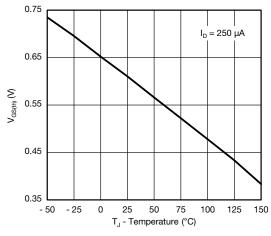
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



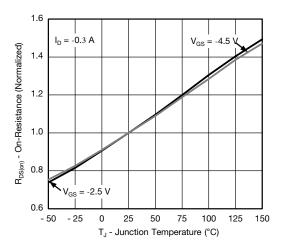
Gate Charge



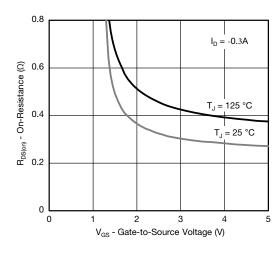
Soure-Drain Diode Forward Voltage



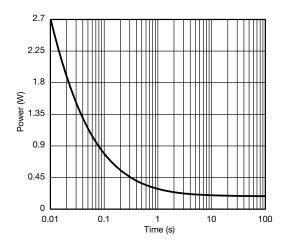
Threshold Voltage



On-Resistance vs. Junction Temperature



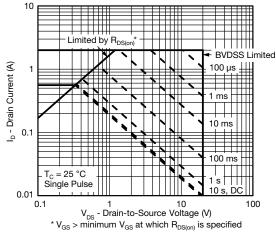
On-Resistance vs. Gate-to-Source Voltage



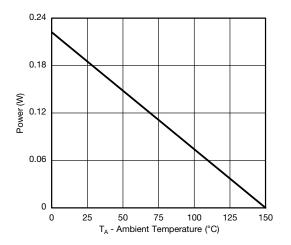
Single Pulse Power, Junction-to-Ambient



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

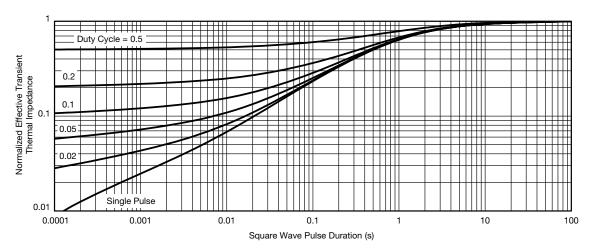






Power Derating, Junction-to-Ambient

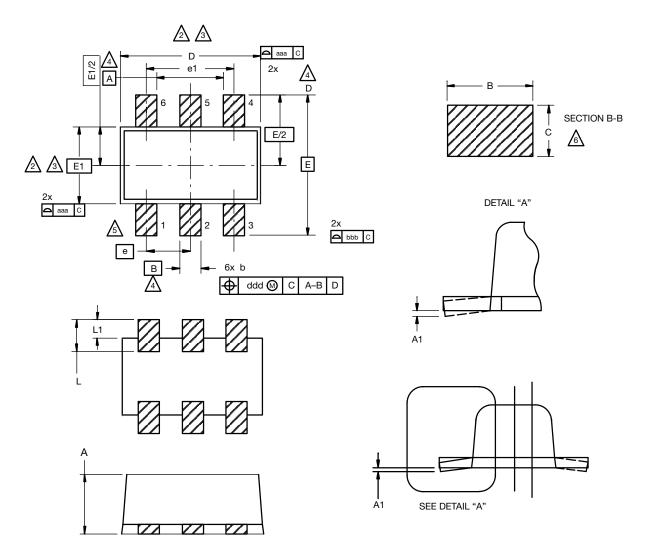
^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



Normalized Thermal Transient Impedance, Junction-to-Ambient



SC-75-6



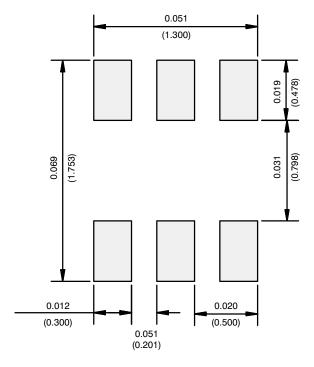
Notes

- 1. Dimensions in millimeters.
- Dimension D does not include mold flash, protrusions or gate burrs. Mold flush, protrusions or gate burrs shall not exceed 0.15 mm per dimension E1 does not include interlead flash or protrusion, interlead flash or protrusion shall not exceed 0.15 mm per side.
- 3. Dimensions D and E1 are determined at the outmost extremes of the plastic body exclusive of mold flash, the bar burrs, gate burrs and interlead flash, but including any mismatch between the top and the bottom of the plastic body.
- 4. Datums A, B and D to be determined 0.10 mm from the lead tip.
- 5. Terminal numbers are shown for reference only.
- 6. These dimensions apply to the flat section of the lead between 0.08 mm and 0.15 mm from the lead tip.

DIM.	MILLIMETERS				
	MIN.	NOM.	MAX.		
Α	0.56	0.58	0.60		
A1	0	0.02	0.10		
q	0.15	0.22	0.30		
С	0.10	0.14	0.18		
D	1.50	1.60	1.70		
Е	1.50	1.60	1.70		
E1	1.15	1.20	1.25		
е	0.45	0.50	0.55		
e1	0.95	1.00	1.05		
L	0.25	0.35	0.50		
L1	0.10	0.20	0.30		



RECOMMENDED MINIMUM PADS FOR SC-75-6: 6-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)



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